Transforming Waste Into Soil Improver

Our Waste Processor Bournemouth UK



Next step from waste to enriched soil _____



Cardboard, paper, food waste



SOIL IMPROVER



Organic landfill content

Process Description

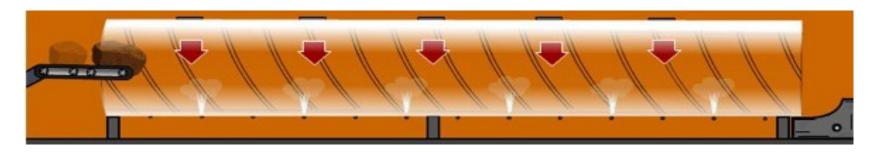
Organic waste is shredded for uniformity to ensure even application of 140°C steam for one hour. The combination of the both factors eradicates all major pathogens, bacteria and prions.



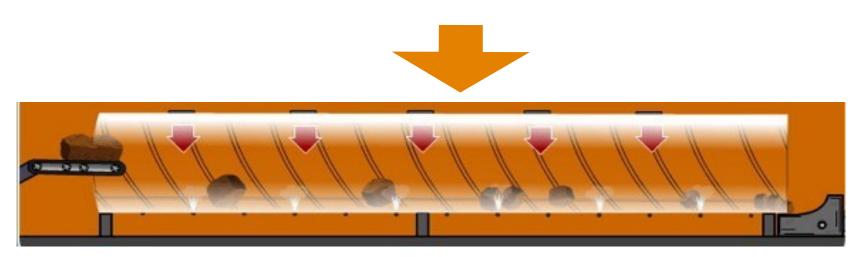


Waste volume is reduced by 50%. The process homogenises waste into uniform biomass, heat and steam starts the composting process.

Process Description



Shredded waste is continually loaded into the rotating Processor and injected with high pressure steam



As waste rotates through the Processor, it is sanitized and reduced in volume

Waste Processor Detail

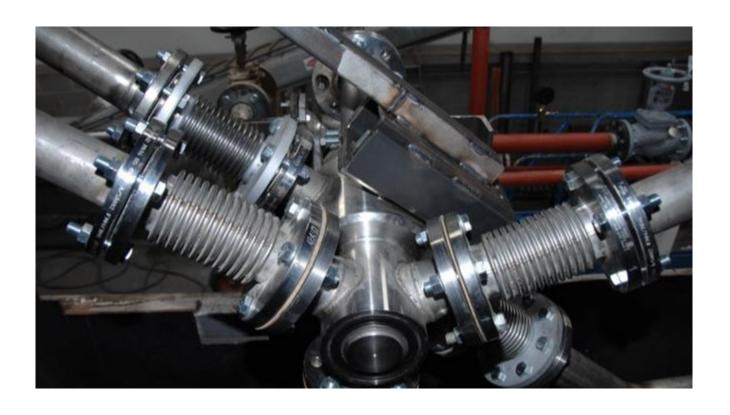


Steam is generated by oil fired boiler rated at 1,75 KW

Internal helix screw and flights arrangement



Waste Processor Detail



The rotary valve allows the distribution of consistent steam flow during the rotation of the Waste Processor

Temperature Control



As with any chamber in rotation, only 25% of volume is occupied and 75% is air. If ambient temperature is 20 °C, then steam, injected at 140 °C, is immediately cooled down.

To compensate, a hot air recirculation system is installed to heat the inside of the Processor, ensuring steam was entering at the required temperature, and being maintained for the duration of the treatment.



Waste Processor Overview

Conversion of organic waste into Soil Improver, Bio-Mass, Briquettes, Pellets

Processing capacity 15 tons per hour, 100,000 tons per year (18 hour operation per day)

Operating at atmospheric pressure and temperature of up to 180° C.

16 m long, 2.7 m diameter, stainless steel (Grade 304L) rotating cylinder.

Open ended, internal helix screw, waste treatment with 8 bar steam at 140°C for one hour.

Low energy usage. No incineration. No harmful emissions.



Water Consumption

600 litres/an hour

Screw presses are used to de-water feedstock prior to treatment

Steam capture provides a possibility to be self-sufficient in water consumption



Requirements of Soil Improver

Destructed latent seeds and/or seedling growth

Sterilized of fungi, bacteria, spores, prions - recommended state of 121-132°C for 60 minutes or 134°C for at least 18 minutes

Pasteurized of liquids - occurs at 140°C for any liquids

Eradicated of human, animal and plant pathogens

Minimal content of non-organic, non-biodegradable content



<u>Organism</u>	Time (in minutes) for destruction of					
	organisms at several temperatures					
	<u>50°C</u>	<u>55°C</u>	<u>60°C</u>	<u>65°C</u>	<u>70°C</u>	
<u>Bacteria</u>						
Salmonella typhi	-	-	30	-	4	
E.coli	-	-	60	-	5	
Mycobacterium tuberculosis	-	-	-	-	20	
Shigella sp.	60	-	-	-	-	
Mycobacterium diphtheriae	-	45	-	-	4	
Brucella abortus	-	60	-	3	-	
Corynebacterium diphtheriae -	45	-	-	4		
<u>Viruses</u>						
Viruses	-	-	-	-	25	
<u>Protozoa</u>						
Entamoeba histolytica cysts	5	-	-	-	-	
<u>Helminths</u>						
Ascaris lumbricoides eggs	60	7	-	-	-	
Necator americanus	50	-	-	-	-	
Taenia saginata		-	-	-	5	

Thermal Death Rates of Common Organisms

<u>Organism</u>	<u>Time (in m</u>	Time (in minutes) for destruction of organisms at several temperatures				
	<u>organisms</u>					
	<u>50°C</u>	<u>55°C</u>	<u>60°C</u>			
Salmonella typhosa	-	30 min	20 min			
Salmonella sp	-	60 min	15-20 min			
Shigella sp	-	60 min	15-20 min			
Escherichia coli	-	60 min	15-20 min			
Streptococcus pyogenes	-	10 min	-			
Mycobacterium diphtheriae	-	45 min	-			
Brucella abortus or suis	-	60 min	3 min			
Entamoeba histolytica (cysts)	1 sec -	_				
Trichinella spiralis	-	-	1 sec			
Necator americanus	50 min	-	-			
Ascaris lumbricoides	-	60 min	-			
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Thermal Death Rates of Common Organisms

Background

- Formation 2011.
- Ownership of Intellectual Property and Waste Processing worldwide patented technology.
- Plant in Bournemouth, Dorset, U.K.
- Focus on the upgrading and testing of the Waste Processor.
- A.A.Thornton & Co patent attorneys oversee worldwide patent applications.